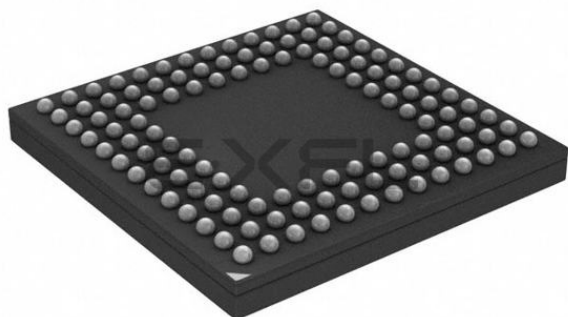




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Details

Product Status	Active
Core Processor	ARM® Cortex®-M4
Core Size	32-Bit Single-Core
Speed	72MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I ² C, IrDA, LINbus, MMC/SD/SDIO, QSPI, SmartCard, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, LCD, POR, PWM, WDT
Number of I/O	95
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.8V
Data Converters	A/D 16x12b SAR; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	120-VFBGA
Supplier Device Package	120-BGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/efm32gg11b820f2048gl120-br

4. Electrical Specifications

4.1 Electrical Characteristics

All electrical parameters in all tables are specified under the following conditions, unless stated otherwise:

- Typical values are based on $T_{AMB}=25\text{ }^{\circ}\text{C}$ and $V_{DD}=3.3\text{ V}$, by production test and/or technology characterization.
- Minimum and maximum values represent the worst conditions across supply voltage, process variation, and operating temperature, unless stated otherwise.

Refer to [4.1.2.1 General Operating Conditions](#) for more details about operational supply and temperature limits.

4.1.1 Absolute Maximum Ratings

Stresses above those listed below may cause permanent damage to the device. This is a stress rating only and functional operation of the devices at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability. For more information on the available quality and reliability data, see the Quality and Reliability Monitor Report at <http://www.silabs.com/support/quality/pages/default.aspx>.

Table 4.1. Absolute Maximum Ratings

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Storage temperature range	T _{STG}		-50	—	150	°C
Voltage on supply pins other than VREGI and VBUS	V _{DDMAX}		-0.3	—	3.8	V
Voltage ramp rate on any supply pin	V _{DDRAMP} MAX		—	—	1	V / μ s
DC voltage on any GPIO pin	V _{DIGPIN}	5V tolerant GPIO pins ^{1 2 3}	-0.3	—	Min of 5.25 and IOVDD +2	V
		LCD pins ³	-0.3	—	Min of 3.8 and IOVDD +2	V
		Standard GPIO pins	-0.3	—	IOVDD+0.3	V
Total current into VDD power lines	I _{VDDMAX}	Source	—	—	200	mA
Total current into VSS ground lines	I _{VSSMAX}	Sink	—	—	200	mA
Current per I/O pin	I _{IOMAX}	Sink	—	—	50	mA
		Source	—	—	50	mA
Current for all I/O pins	I _{IOALLMAX}	Sink	—	—	200	mA
		Source	—	—	200	mA
Junction temperature	T _J	-G grade devices	-40	—	105	°C
		-I grade devices	-40	—	125	°C
Voltage on regulator supply pins VREGI and VBUS	V _{VREGI}		-0.3	—	5.5	V

Note:

1. When a GPIO pin is routed to the analog module through the APORT, the maximum voltage = IOVDD.
2. Valid for IOVDD in valid operating range or when IOVDD is undriven (high-Z). If IOVDD is connected to a low-impedance source below the valid operating range (e.g. IOVDD shorted to VSS), the pin voltage maximum is IOVDD + 0.3 V, to avoid exceeding the maximum IO current specifications.
3. To operate above the IOVDD supply rail, over-voltage tolerance must be enabled according to the GPIO_Px_OVTDIS register. Pins with over-voltage tolerance disabled have the same limits as Standard GPIO.

4.1.7 Current Consumption

4.1.7.1 Current Consumption 3.3 V without DC-DC Converter

Unless otherwise indicated, typical conditions are: VREGVDD = AVDD = DVDD = 3.3 V. T = 25 °C. DCDC is off. Minimum and maximum values in this table represent the worst conditions across supply voltage and process variation at T = 25 °C.

Table 4.7. Current Consumption 3.3 V without DC-DC Converter

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Current consumption in EM0 mode with all peripherals disabled	I _{ACTIVE}	72 MHz HFRCO, CPU running Prime from flash	—	120	—	μA/MHz
		72 MHz HFRCO, CPU running while loop from flash	—	120	TBD	μA/MHz
		72 MHz HFRCO, CPU running CoreMark loop from flash	—	140	—	μA/MHz
		50 MHz crystal, CPU running while loop from flash	—	123	—	μA/MHz
		48 MHz HFRCO, CPU running while loop from flash	—	122	TBD	μA/MHz
		32 MHz HFRCO, CPU running while loop from flash	—	124	—	μA/MHz
		26 MHz HFRCO, CPU running while loop from flash	—	126	TBD	μA/MHz
		16 MHz HFRCO, CPU running while loop from flash	—	131	—	μA/MHz
		1 MHz HFRCO, CPU running while loop from flash	—	319	TBD	μA/MHz
Current consumption in EM0 mode with all peripherals disabled and voltage scaling enabled	I _{ACTIVE_VS}	19 MHz HFRCO, CPU running while loop from flash	—	107	—	μA/MHz
		1 MHz HFRCO, CPU running while loop from flash	—	262	—	μA/MHz
Current consumption in EM1 mode with all peripherals disabled	I _{EM1}	72 MHz HFRCO	—	57	TBD	μA/MHz
		50 MHz crystal	—	60	—	μA/MHz
		48 MHz HFRCO	—	59	TBD	μA/MHz
		32 MHz HFRCO	—	61	—	μA/MHz
		26 MHz HFRCO	—	63	TBD	μA/MHz
		16 MHz HFRCO	—	68	—	μA/MHz
		1 MHz HFRCO	—	255	TBD	μA/MHz
Current consumption in EM1 mode with all peripherals disabled and voltage scaling enabled	I _{EM1_VS}	19 MHz HFRCO	—	55	—	μA/MHz
		1 MHz HFRCO	—	210	—	μA/MHz

4.1.10.4 High-Frequency RC Oscillator (HFRCO)

Table 4.15. High-Frequency RC Oscillator (HFRCO)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Frequency accuracy	$f_{\text{HFRCO_ACC}}$	At production calibrated frequencies, across supply voltage and temperature	TBD	—	TBD	%
Start-up time	t_{HFRCO}	$f_{\text{HFRCO}} \geq 19 \text{ MHz}$	—	300	—	ns
		$4 < f_{\text{HFRCO}} < 19 \text{ MHz}$	—	1	—	μs
		$f_{\text{HFRCO}} \leq 4 \text{ MHz}$	—	2.5	—	μs
Maximum DPLL lock time ¹	$t_{\text{DPLL_LOCK}}$	$f_{\text{REF}} = 32.768 \text{ kHz}$, $f_{\text{HFRCO}} = 39.98 \text{ MHz}$, $N = 1219$, $M = 0$	—	183	—	μs
Current consumption on all supplies	I_{HFRCO}	$f_{\text{HFRCO}} = 72 \text{ MHz}$	—	608	TBD	μA
		$f_{\text{HFRCO}} = 64 \text{ MHz}$	—	545	TBD	μA
		$f_{\text{HFRCO}} = 56 \text{ MHz}$	—	478	TBD	μA
		$f_{\text{HFRCO}} = 48 \text{ MHz}$	—	413	TBD	μA
		$f_{\text{HFRCO}} = 38 \text{ MHz}$	—	341	TBD	μA
		$f_{\text{HFRCO}} = 32 \text{ MHz}$	—	286	TBD	μA
		$f_{\text{HFRCO}} = 26 \text{ MHz}$	—	240	TBD	μA
		$f_{\text{HFRCO}} = 19 \text{ MHz}$	—	191	TBD	μA
		$f_{\text{HFRCO}} = 16 \text{ MHz}$	—	164	TBD	μA
		$f_{\text{HFRCO}} = 13 \text{ MHz}$	—	143	TBD	μA
		$f_{\text{HFRCO}} = 7 \text{ MHz}$	—	103	TBD	μA
		$f_{\text{HFRCO}} = 4 \text{ MHz}$	—	42	TBD	μA
		$f_{\text{HFRCO}} = 2 \text{ MHz}$	—	33	TBD	μA
		$f_{\text{HFRCO}} = 1 \text{ MHz}$	—	28	TBD	μA
		$f_{\text{HFRCO}} = 72 \text{ MHz}$, DPLL enabled	—	927	TBD	μA
		$f_{\text{HFRCO}} = 40 \text{ MHz}$, DPLL enabled	—	526	TBD	μA
		$f_{\text{HFRCO}} = 32 \text{ MHz}$, DPLL enabled	—	419	TBD	μA
		$f_{\text{HFRCO}} = 16 \text{ MHz}$, DPLL enabled	—	233	TBD	μA
		$f_{\text{HFRCO}} = 4 \text{ MHz}$, DPLL enabled	—	59	TBD	μA
		$f_{\text{HFRCO}} = 1 \text{ MHz}$, DPLL enabled	—	36	TBD	μA
Coarse trim step size (% of period)	$SS_{\text{HFRCO_COARSE}}$		—	0.8	—	%
Fine trim step size (% of period)	$SS_{\text{HFRCO_FINE}}$		—	0.1	—	%
Period jitter	PJ_{HFRCO}		—	0.2	—	% RMS

4.1.16 Digital to Analog Converter (VDAC)

DRIVESTRENGTH = 2 unless otherwise specified. Primary VDAC output.

Table 4.24. Digital to Analog Converter (VDAC)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Output voltage	V_{DACOUT}	Single-Ended	0	—	V_{VREF}	V
		Differential ²	$-V_{VREF}$	—	V_{VREF}	V
Current consumption including references (2 channels) ¹	I_{DAC}	500 ksps, 12-bit, DRIVESTRENGTH = 2, REFSEL = 4	—	402	—	μA
		44.1 ksps, 12-bit, DRIVESTRENGTH = 1, REFSEL = 4	—	88	—	μA
		200 Hz refresh rate, 12-bit Sample-Off mode in EM2, DRIVESTRENGTH = 2, BGRREQTIME = 1, EM2REFENTIME = 9, REFSEL = 4, SETTLETIME = 0x0A, WARMUPTIME = 0x02	—	2	—	μA
Current from HFPERCLK ⁴	I_{DAC_CLK}		—	5.25	—	$\mu A/MHz$
Sample rate	SR_{DAC}		—	—	500	ksps
DAC clock frequency	f_{DAC}		—	—	1	MHz
Conversion time	$t_{DACCONV}$	$f_{DAC} = 1MHz$	2	—	—	μs
Settling time	$t_{DACSETTLE}$	50% fs step settling to 5 LSB	—	2.5	—	μs
Startup time	$t_{DACSTARTUP}$	Enable to 90% fs output, settling to 10 LSB	—	—	12	μs
Output impedance	R_{OUT}	DRIVESTRENGTH = 2, $0.4 V \leq V_{OUT} \leq V_{OPA} - 0.4 V$, $-8 mA < I_{OUT} < 8 mA$, Full supply range	—	2	—	Ω
		DRIVESTRENGTH = 0 or 1, $0.4 V \leq V_{OUT} \leq V_{OPA} - 0.4 V$, $-400 \mu A < I_{OUT} < 400 \mu A$, Full supply range	—	2	—	Ω
		DRIVESTRENGTH = 2, $0.1 V \leq V_{OUT} \leq V_{OPA} - 0.1 V$, $-2 mA < I_{OUT} < 2 mA$, Full supply range	—	2	—	Ω
		DRIVESTRENGTH = 0 or 1, $0.1 V \leq V_{OUT} \leq V_{OPA} - 0.1 V$, $-100 \mu A < I_{OUT} < 100 \mu A$, Full supply range	—	2	—	Ω
Power supply rejection ratio ⁶	PSRR	$V_{out} = 50\% fs$, DC	—	65.5	—	dB

4.1.23 I2C

4.1.23.1 I2C Standard-mode (Sm)¹

Table 4.31. I2C Standard-mode (Sm)¹

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
SCL clock frequency ²	f _{SCL}		0	—	100	kHz
SCL clock low time	t _{LOW}		4.7	—	—	μs
SCL clock high time	t _{HIGH}		4	—	—	μs
SDA set-up time	t _{SU_DAT}		250	—	—	ns
SDA hold time ³	t _{HD_DAT}		100	—	3450	ns
Repeated START condition set-up time	t _{SU_STA}		4.7	—	—	μs
(Repeated) START condition hold time	t _{HD_STA}		4	—	—	μs
STOP condition set-up time	t _{SU_STO}		4	—	—	μs
Bus free time between a STOP and START condition	t _{BUF}		4.7	—	—	μs

Note:

1. For CLHR set to 0 in the I2Cn_CTRL register.
2. For the minimum HPERCLK frequency required in Standard-mode, refer to the I2C chapter in the reference manual.
3. The maximum SDA hold time (t_{HD_DAT}) needs to be met only when the device does not stretch the low time of SCL (t_{LOW}).

SDIO HS Mode Timing

Timing is specified for route location 0 at 3.0 V IOVDD with voltage scaling disabled. Slew rate for SD_CLK set to 7, all other GPIO set to 6, DRIVESTRENGTH = STRONG for all pins. SDIO_CTRL_TXDLYMUXSEL = 0. Loading between 5 and 10 pF on all pins or between 10 and 20 pF on all pins.

Table 4.47. SDIO HS Mode Timing (Location 0)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Clock frequency during data transfer	F _{SD_CLK}	Using HFRCO, AUXHFRCO, or USHFRCO	—	—	45	MHz
		Using HFXO	—	—	TBD	MHz
Clock low time	t _{WL}	Using HFRCO, AUXHFRCO, or USHFRCO	10.0	—	—	ns
		Using HFXO	TBD	—	—	ns
Clock high time	t _{WH}	Using HFRCO, AUXHFRCO, or USHFRCO	10.0	—	—	ns
		Using HFXO	TBD	—	—	ns
Clock rise time	t _R		1.69	3.23	—	ns
Clock fall time	t _F		1.42	2.79	—	ns
Input setup time, CMD, DAT[0:3] valid to SD_CLK	t _{ISU}		6	—	—	ns
Input hold time, SD_CLK to CMD, DAT[0:3] change	t _{IH}		2.5	—	—	ns
Output delay time, SD_CLK to CMD, DAT[0:3] valid	t _{ODLY}		0	—	13	ns
Output hold time, SD_CLK to CMD, DAT[0:3] change	t _{OH}		2	—	—	ns

5. Pin Definitions

5.1 EFM32GG11B8xx in BGA192 Device Pinout

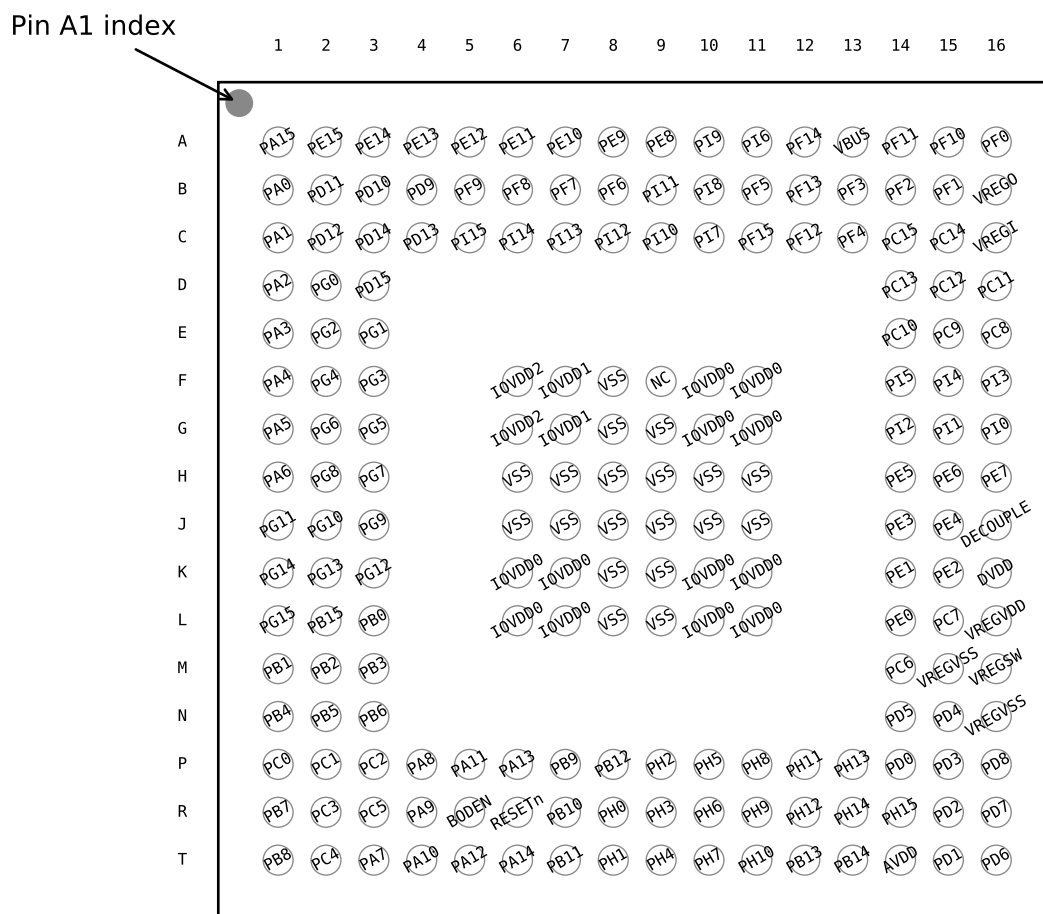


Figure 5.1. EFM32GG11B8xx in BGA192 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see [5.20 GPIO Functionality Table](#) or [5.21 Alternate Functionality Overview](#).

Table 5.1. EFM32GG11B8xx in BGA192 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PA15	A1	GPIO	PE15	A2	GPIO
PE14	A3	GPIO	PE13	A4	GPIO
PE12	A5	GPIO	PE11	A6	GPIO
PE10	A7	GPIO	PE9	A8	GPIO
PE8	A9	GPIO	PI9	A10	GPIO (5V)
PI6	A11	GPIO (5V)	PF14	A12	GPIO (5V)

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
IOVDD1	F7 G7	Digital IO power supply 1.	VSS	F8 G8 G9 H6 H7 H8 H9 H10 H11 J6 J7 J8 J9 J10 J11 K8 K9 L8 L9	Ground
NC	F9	No Connect.	IOVDD0	F10 F11 G10 G11 K6 K7 K10 K11 L6 L7 L10 L11	Digital IO power supply 0.
PI5	F14	GPIO (5V)	PI4	F15	GPIO (5V)
PI3	F16	GPIO (5V)	PA5	G1	GPIO
PG6	G2	GPIO (5V)	PG5	G3	GPIO (5V)
PI2	G14	GPIO (5V)	PI1	G15	GPIO (5V)
PI0	G16	GPIO (5V)	PA6	H1	GPIO
PG8	H2	GPIO (5V)	PG7	H3	GPIO (5V)
PE5	H14	GPIO	PE6	H15	GPIO
PE7	H16	GPIO	PG11	J1	GPIO (5V)
PG10	J2	GPIO (5V)	PG9	J3	GPIO (5V)
PE3	J14	GPIO	PE4	J15	GPIO
DECOUPLE	J16	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.	PG14	K1	GPIO
PG13	K2	GPIO	PG12	K3	GPIO
PE1	K14	GPIO (5V)	PE2	K15	GPIO
DVDD	K16	Digital power supply.	PG15	L1	GPIO (5V)
PB15	L2	GPIO (5V)	PB0	L3	GPIO
PE0	L14	GPIO (5V)	PC7	L15	GPIO
VREGVDD	L16	Voltage regulator VDD input	PB1	M1	GPIO

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PB2	11	GPIO	PB3	12	GPIO
PB4	13	GPIO	PB5	14	GPIO
PB6	15	GPIO	VSS	16 32 59 83	Ground
PC0	18	GPIO (5V)	PC1	19	GPIO (5V)
PC2	20	GPIO (5V)	PC3	21	GPIO (5V)
PC4	22	GPIO	PC5	23	GPIO
PB7	24	GPIO	PB8	25	GPIO
PA7	26	GPIO	PA8	27	GPIO
PA9	28	GPIO	PA10	29	GPIO
PA11	30	GPIO	PA12	33	GPIO (5V)
PA13	34	GPIO (5V)	PA14	35	GPIO
RESETn	36	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.	PB9	37	GPIO (5V)
PB10	38	GPIO (5V)	PB11	39	GPIO
PB12	40	GPIO	AVDD	41	Analog power supply.
PB13	42	GPIO	PB14	43	GPIO
PD0	45	GPIO (5V)	PD1	46	GPIO
PD2	47	GPIO (5V)	PD3	48	GPIO
PD4	49	GPIO	PD5	50	GPIO
PD6	51	GPIO	PD7	52	GPIO
PD8	53	GPIO	PC7	54	GPIO
VREGVSS	55	Voltage regulator VSS	VREGSW	56	DCDC regulator switching node
VREGVDD	57	Voltage regulator VDD input	DVDD	58	Digital power supply.
DECOUPLE	60	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.	PE1	61	GPIO (5V)
PE2	62	GPIO	PE3	63	GPIO
PE4	64	GPIO	PE5	65	GPIO
PE6	66	GPIO	PE7	67	GPIO
PC8	68	GPIO (5V)	PC9	69	GPIO (5V)
PC10	70	GPIO (5V)	PC11	71	GPIO (5V)
VREGI	72	Input to 5 V regulator.	VREGO	73	Decoupling for 5 V regulator and regulator output. Power for USB PHY in USB-enabled OPNs
PF10	74	GPIO (5V)	PF11	75	GPIO (5V)
PF0	76	GPIO (5V)	PF1	77	GPIO (5V)

5.10 EFM32GG11B4xx in QFP100 Device Pinout

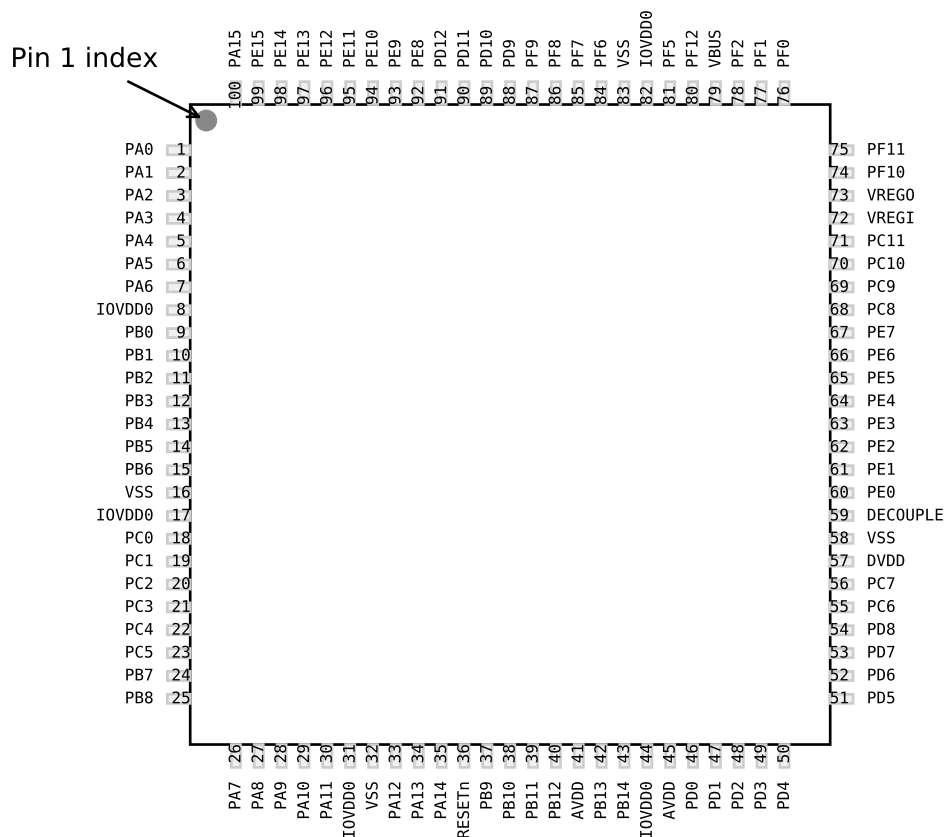


Figure 5.10. EFM32GG11B4xx in QFP100 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see [5.20 GPIO Functionality Table](#) or [5.21 Alternate Functionality Overview](#).

Table 5.10. EFM32GG11B4xx in QFP100 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PA0	1	GPIO	PA1	2	GPIO
PA2	3	GPIO	PA3	4	GPIO
PA4	5	GPIO	PA5	6	GPIO
PA6	7	GPIO	IOVDD0	8 17 31 44 82	Digital IO power supply 0.
PB0	9	GPIO	PB1	10	GPIO

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PB6	12	GPIO	PC4	13	GPIO
PC5	14	GPIO	PB7	15	GPIO
PB8	16	GPIO	PA12	17	GPIO (5V)
PA13	18	GPIO (5V)	PA14	19	GPIO
RESETn	20	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.	PB11	21	GPIO
PB12	22	GPIO	AVDD	23 27	Analog power supply.
PB13	24	GPIO	PB14	25	GPIO
PD0	28	GPIO (5V)	PD1	29	GPIO
PD2	30	GPIO (5V)	PD3	31	GPIO
PD4	32	GPIO	PD5	33	GPIO
PD6	34	GPIO	PD7	35	GPIO
PD8	36	GPIO	PC6	37	GPIO
PC7	38	GPIO	DVDD	39	Digital power supply.
DECOUPLE	40	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.	PE4	41	GPIO
PE5	42	GPIO	PE6	43	GPIO
PE7	44	GPIO	VREGI	45	Input to 5 V regulator.
VREGO	46	Decoupling for 5 V regulator and regulator output. Power for USB PHY in USB-enabled OPNs	PF10	47	GPIO (5V)
PF11	48	GPIO (5V)	PF0	49	GPIO (5V)
PF1	50	GPIO (5V)	PF2	51	GPIO
VBUS	52	USB VBUS signal and auxiliary input to 5 V regulator.	PF12	53	GPIO
PF5	54	GPIO	PE8	56	GPIO
PE9	57	GPIO	PE10	58	GPIO
PE11	59	GPIO	PE12	60	GPIO
PE13	61	GPIO	PE14	62	GPIO
PE15	63	GPIO	PA15	64	GPIO

Note:

1. GPIO with 5V tolerance are indicated by (5V).

5.19 EFM32GG11B1xx in QFN64 Device Pinout

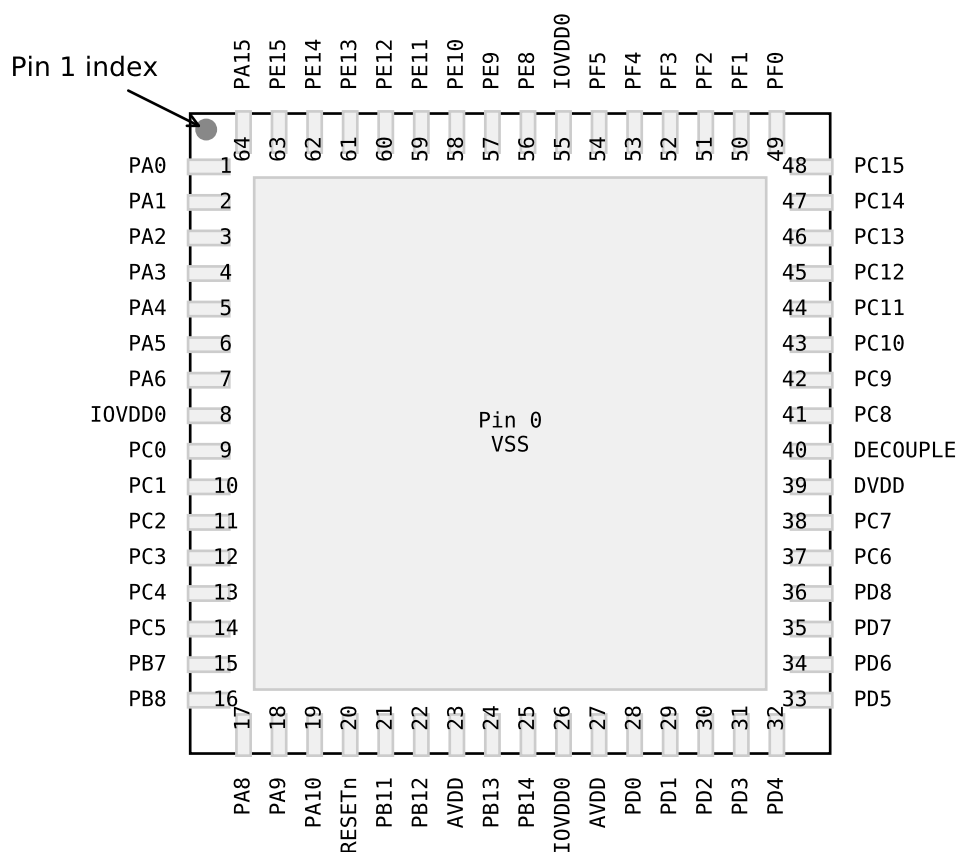


Figure 5.19. EFM32GG11B1xx in QFN64 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see [5.20 GPIO Functionality Table](#) or [5.21 Alternate Functionality Overview](#).

Table 5.19. EFM32GG11B1xx in QFN64 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
VSS	0	Ground	PA0	1	GPIO
PA1	2	GPIO	PA2	3	GPIO
PA3	4	GPIO	PA4	5	GPIO
PA5	6	GPIO	PA6	7	GPIO
IOVDD0	8 26 55	Digital IO power supply 0.	PC0	9	GPIO (5V)
PC1	10	GPIO (5V)	PC2	11	GPIO (5V)

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
EBI_A10	0: PE3 1: PD6 2: PC10 3: PB10		External Bus Interface (EBI) address output pin 10.
EBI_A11	0: PE4 1: PD7 2: PI6 3: PB11		External Bus Interface (EBI) address output pin 11.
EBI_A12	0: PE5 1: PD8 2: PI7 3: PB12		External Bus Interface (EBI) address output pin 12.
EBI_A13	0: PE6 1: PC7 2: PI8 3: PD0		External Bus Interface (EBI) address output pin 13.
EBI_A14	0: PE7 1: PE2 2: PI9 3: PD1		External Bus Interface (EBI) address output pin 14.
EBI_A15	0: PC8 1: PE3 2: PI10 3: PD2		External Bus Interface (EBI) address output pin 15.
EBI_A16	0: PB0 1: PE4 2: PH4 3: PD3		External Bus Interface (EBI) address output pin 16.
EBI_A17	0: PB1 1: PE5 2: PH5 3: PD4		External Bus Interface (EBI) address output pin 17.
EBI_A18	0: PB2 1: PE6 2: PH6 3: PD5		External Bus Interface (EBI) address output pin 18.
EBI_A19	0: PB3 1: PE7 2: PH7 3: PD6		External Bus Interface (EBI) address output pin 19.
EBI_A20	0: PB4 1: PC8 2: PH8 3: PD7		External Bus Interface (EBI) address output pin 20.
EBI_A21	0: PB5 1: PC9 2: PH9 3: PC7		External Bus Interface (EBI) address output pin 21.
EBI_A22	0: PB6 1: PC10 2: PH10 3: PE4		External Bus Interface (EBI) address output pin 22.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
ETH_TSUTMR-TOG	0: PB6 1: PB15 2: PC3 3: PF9		Ethernet IEEE1588 Timer Toggle.
ETM_TCLK	0: PD7 1: PF8 2: PC6 3: PA6	4: PE11 5: PG15	Embedded Trace Module ETM clock .
ETM_TD0	0: PD6 1: PF9 2: PC7 3: PA2	4: PE12 5: PG14	Embedded Trace Module ETM data 0.
ETM_TD1	0: PD3 1: PD13 2: PD3 3: PA3	4: PE13 5: PG13	Embedded Trace Module ETM data 1.
ETM_TD2	0: PD4 1: PB15 2: PD4 3: PA4	4: PE14 5: PG12	Embedded Trace Module ETM data 2.
ETM_TD3	0: PD5 1: PF3 2: PD5 3: PA5	4: PE15 5: PG11	Embedded Trace Module ETM data 3.
GPIO_EM4WU0	0: PA0		Pin can be used to wake the system up from EM4
GPIO_EM4WU1	0: PA6		Pin can be used to wake the system up from EM4
GPIO_EM4WU2	0: PC9		Pin can be used to wake the system up from EM4
GPIO_EM4WU3	0: PF1		Pin can be used to wake the system up from EM4
GPIO_EM4WU4	0: PF2		Pin can be used to wake the system up from EM4
GPIO_EM4WU5	0: PE13		Pin can be used to wake the system up from EM4
GPIO_EM4WU6	0: PC4		Pin can be used to wake the system up from EM4

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
US5_RX	0: PE9 1: PA7 2: PB1 3: PH11		USART5 Asynchronous Receive. USART5 Synchronous mode Master Input / Slave Output (MISO).
US5_TX	0: PE8 1: PA6 2: PF15 3: PH10		USART5 Asynchronous Transmit. Also used as receive input in half duplex communication. USART5 Synchronous mode Master Output / Slave Input (MOSI).
USB_DM	0: PF10		USB D- pin.
USB_DP	0: PF11		USB D+ pin.
USB_ID	0: PF12		USB ID pin.
USB_VBUSEN	0: PF5		USB 5 V VBUS enable.
VDAC0_EXT	0: PD6		Digital to analog converter VDAC0 external reference input pin.
VDAC0_OUT0 / OPA0_OUT	0: PB11		Digital to Analog Converter DAC0 output channel number 0.
VDAC0_OUT0ALT / OPA0_OUTALT	0: PC0 1: PC1 2: PC2 3: PC3	4: PD0	Digital to Analog Converter DAC0 alternative output for channel 0.
VDAC0_OUT1 / OPA1_OUT	0: PB12		Digital to Analog Converter DAC0 output channel number 1.
VDAC0_OUT1ALT / OPA1_OUTALT	0: PC12 1: PC13 2: PC14 3: PC15	4: PD1	Digital to Analog Converter DAC0 alternative output for channel 1.
WTIM0_CC0	0: PE4 1: PA6 2: PG2 3: PG8	4: PC15 5: PB0 6: PB3 7: PC1	Wide timer 0 Capture Compare input / output channel 0.
WTIM0_CC1	0: PE5 1: PD13 2: PG3 3: PG9	4: PF0 5: PB1 6: PB4 7: PC2	Wide timer 0 Capture Compare input / output channel 1.

Port	Bus	CH31	CH30	CH29	CH28	CH27	CH26	CH25	CH24	CH23	CH22	CH21	CH20	CH19	CH18	CH17	CH16	CH15	CH14	CH13	CH12	CH11	CH10	CH9	CH8	CH7	CH6	CH5	CH4	CH3	CH2	CH1	CH0
OPA1_N																																	
APORT1Y	BUSAY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY
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APORT2Y	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY
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APORT3Y	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY
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APORT4Y	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY
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OPA1_P																																	
APORT1X	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX	BUSAX
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APORT2X	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX
	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX	BUSBX
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APORT3X	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX	BUSCX
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APORT4X	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY	BUSDY
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OPA2_N																																	
APORT1Y	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY	BUSAY
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APORT2Y	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY	BUSBY
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6.3 BGA192 Package Marking



Figure 6.3. BGA192 Package Marking

The package marking consists of:

- P P P P P P P P P P – The part number designation.
- T T T T T T – A trace or manufacturing code. The first letter is the device revision.
- Y Y – The last 2 digits of the assembly year.
- W W – The 2-digit workweek when the device was assembled.

9. BGA112 Package Specifications

9.1 BGA112 Package Dimensions

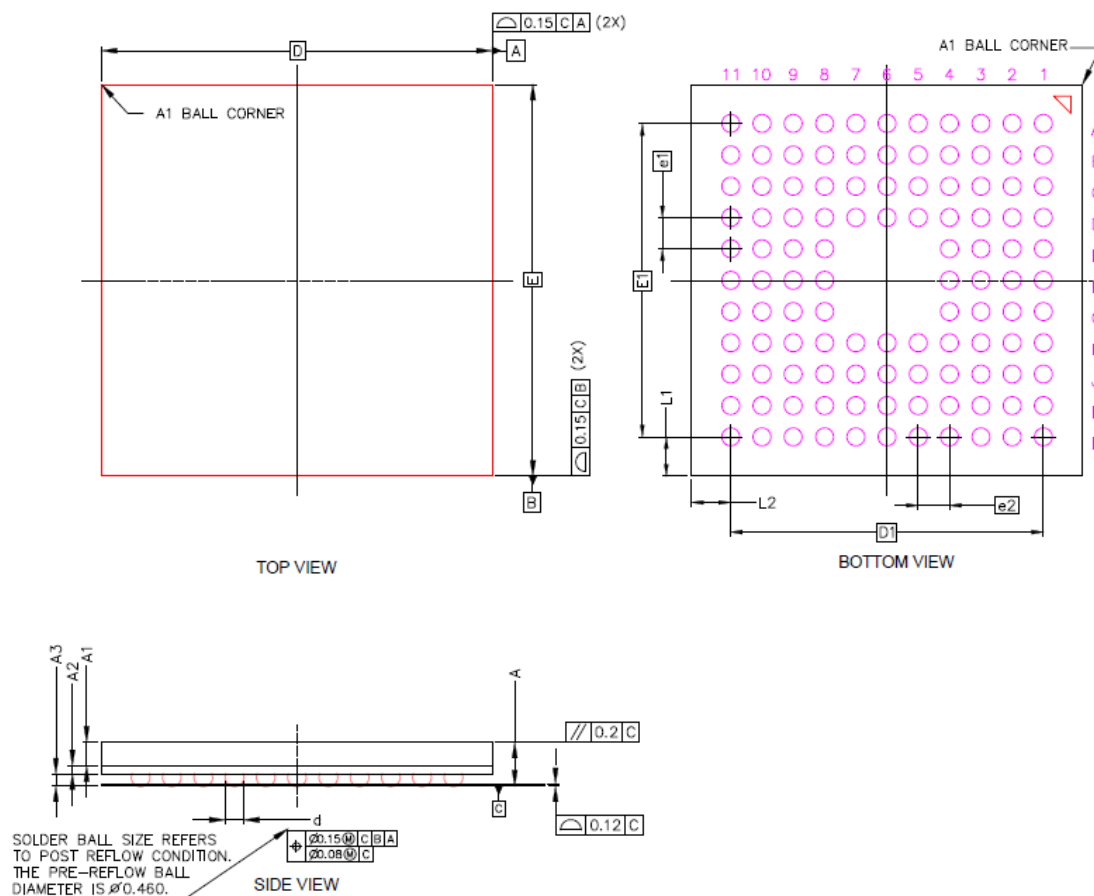


Figure 9.1. BGA112 Package Drawing

10.2 TQFP100 PCB Land Pattern

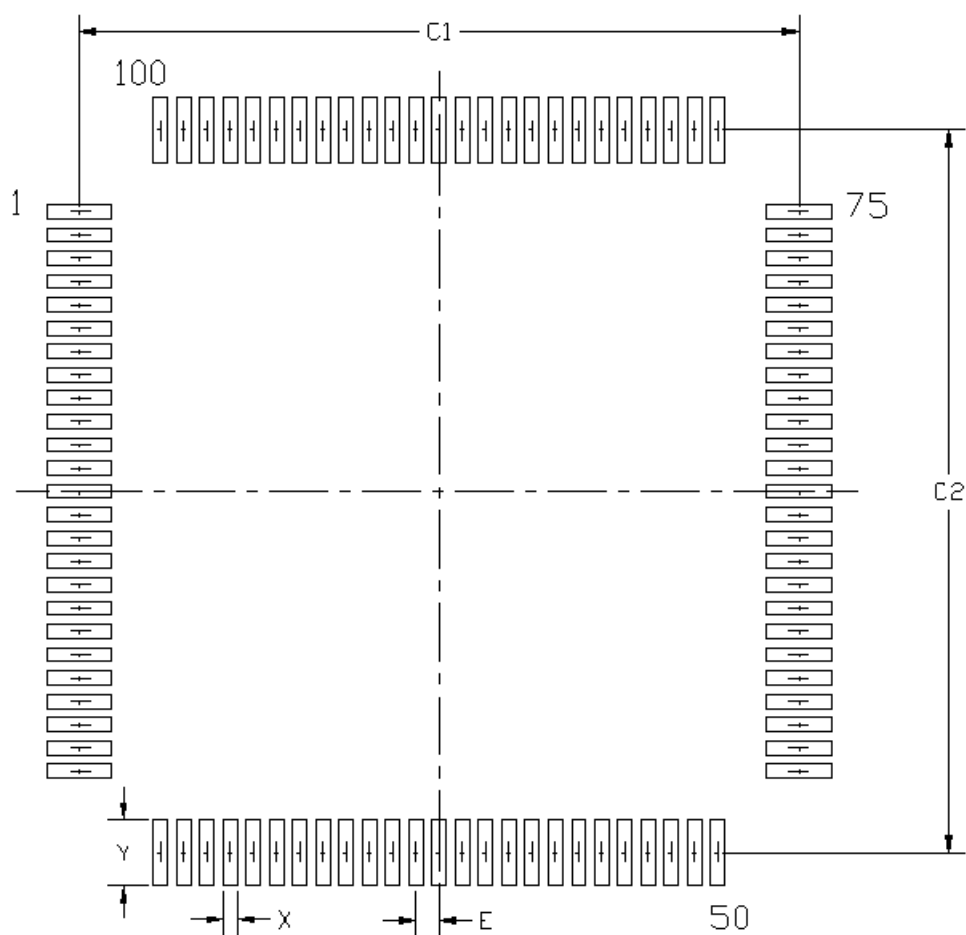


Figure 10.2. TQFP100 PCB Land Pattern Drawing